To our customers,

**Old Company Name in Catalogs and Other Documents**

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Renesas Electronics website: http://www.renesas.com

April 1\textsuperscript{st}, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DESCRIPTION
The PS7804-1A is a low output capacitance solid state relay containing a GaAs LED on the light emitting side (input side) and MOS FETs on the output side.

An ultra small flat-lead package has been provided which realizes a reduction in mounting area of about 50% compared with the PS72xx series.

It is suitable for high-frequency signal control, due to its low C × R, low output capacitance, and low off-state leakage current.

FEATURES

- Ultra small flat-lead package (4.2 (L) × 2.5 (W) × 1.85 (H) mm)
- Low C × R (C × R = 30 pF × Ω)
- Low on-state resistance (R_on = 1.1 Ω TYP.)
- Large continuous load current (I_L = 400 mA)
- 1 channel type (1 output)
- Designed for AC/DC switching line changer
- Low offset voltage
- Ordering number of taping product: PS7804-1A-F3: 3 500 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: No. E72422

APPLICATIONS

- Measurement equipment

PIN CONNECTION
(Top View)

1. LED Anode
2. LED Cathode
3. MOS FET
4. MOS FET
PACKAGE DIMENSIONS (UNIT: mm)

MARKING EXAMPLE

- The marking corresponds to the last two digits of the part number below.
- PS7804-1A
- Bar: Pb-Free
ORDERING INFORMATION

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Order Number</th>
<th>Solder Plating Specification</th>
<th>Packing Style</th>
<th>Safety Standard Approval</th>
<th>Application Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>PS7804-1A</td>
<td>PS7804-1A-A</td>
<td>Pb-Free</td>
<td>50 pcs (Tape 50 pcs cut)</td>
<td>Standard products</td>
<td>PS7804-1A</td>
</tr>
<tr>
<td>PS7804-1A-F3</td>
<td>PS7804-1A-F3-A</td>
<td>Embossed Tape 3 500 pcs/reel</td>
<td></td>
<td>(UL approved)</td>
<td></td>
</tr>
</tbody>
</table>

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Ratings</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Diode</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forward Current (DC)</td>
<td>I₉</td>
<td>50</td>
<td>mA</td>
</tr>
<tr>
<td>Reverse Voltage</td>
<td>Vᵣ</td>
<td>5.0</td>
<td>V</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>P₉</td>
<td>50</td>
<td>mW</td>
</tr>
<tr>
<td>Peak Forward Current *1</td>
<td>I₉P</td>
<td>1</td>
<td>A</td>
</tr>
<tr>
<td>MOS FET</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Break Down Voltage</td>
<td>Vₛ</td>
<td>60</td>
<td>V</td>
</tr>
<tr>
<td>Continuous Load Current</td>
<td>Iₛ</td>
<td>400</td>
<td>mA</td>
</tr>
<tr>
<td>Pulse Load Current *2 (AC/DC Connection)</td>
<td>IₛP</td>
<td>800</td>
<td>mA</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>Pₛ</td>
<td>250</td>
<td>mW</td>
</tr>
<tr>
<td>Isolation Voltage *3</td>
<td>BV</td>
<td>500</td>
<td>Vr.m.s.</td>
</tr>
<tr>
<td>Total Power Dissipation</td>
<td>Pₛ</td>
<td>300</td>
<td>mW</td>
</tr>
<tr>
<td>Operating Ambient Temperature</td>
<td>Tₘ</td>
<td>−40 to +85</td>
<td>°C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>Tₘₛ</td>
<td>−40 to +100</td>
<td>°C</td>
</tr>
</tbody>
</table>

*1 PW = 100 μs, Duty Cycle = 1%
*2 PW = 100 ms, 1 shot
*3 AC voltage for 1 minute at TA = 25°C, RH = 60% between input and output.
   Pins 1-2 shorted together, 3-4 shorted together.

RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>MIN.</th>
<th>TYP.</th>
<th>MAX.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>LED Operating Current</td>
<td>Iᵣ</td>
<td>4.5</td>
<td>5</td>
<td>20</td>
<td>mA</td>
</tr>
<tr>
<td>LED Off Current</td>
<td>Iᵣ₀</td>
<td>0.1</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
</tbody>
</table>
# ELECTRICAL CHARACTERISTICS (TA = 25°C)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Conditions</th>
<th>MIN.</th>
<th>TYP.</th>
<th>MAX.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Diode</td>
<td>V_F</td>
<td>I_F = 5 mA</td>
<td>1.1</td>
<td>1.4</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Reverse Current</td>
<td>I_H</td>
<td>V_H = 5 V</td>
<td>5.0</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>MOS FET Off-state Leakage Current</td>
<td>I_Loff</td>
<td>V_D = 60 V</td>
<td>0.1</td>
<td>1.0</td>
<td></td>
<td>nA</td>
</tr>
<tr>
<td>Output Capacitance</td>
<td>C_out</td>
<td>V_D = 0 V, f = 1 MHz</td>
<td>27</td>
<td>35</td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td>Coupled On-state Current</td>
<td>I_on</td>
<td>I_L = 400 mA</td>
<td></td>
<td>1.1</td>
<td>1.5</td>
<td>mA</td>
</tr>
<tr>
<td>On-state Resistance</td>
<td>R_on</td>
<td>I_F = 5 mA, I_L = 400 mA, t ≤ 10 ms</td>
<td></td>
<td>0.15</td>
<td>0.5</td>
<td>ms</td>
</tr>
<tr>
<td>Turn-on Time&lt;sup&gt;*,1&lt;/sup&gt;</td>
<td>t_on</td>
<td>I_F = 5 mA, V_O = 5 V, R_L = 500 Ω,</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Turn-off Time&lt;sup&gt;*,2&lt;/sup&gt;</td>
<td>t_off</td>
<td>PW ≥ 2 ms</td>
<td>0.05</td>
<td>0.5</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Isolation Resistance</td>
<td>R_I-O</td>
<td>V_I-O = 0.5 kVDC</td>
<td></td>
<td>10&lt;sup&gt;9&lt;/sup&gt;</td>
<td></td>
<td>Ω</td>
</tr>
<tr>
<td>Isolation Capacitance</td>
<td>C_I-O</td>
<td>V = 0 V, f = 1 MHz</td>
<td></td>
<td>0.3</td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>

<sup>1</sup> Test Circuit for Switching Time

<sup>2</sup> The turn-on time and turn-off time are specified as input-pulse width ≥ 2 ms.
Be aware that when the device operates with an input-pulse width less than 2 ms, the turn-on time and turn-off time will increase.
TAPING SPECIFICATIONS (UNIT: mm)

Outline and Dimensions (Tape)

Outine and Dimensions (Reel)

Packing: 3 500 pcs/reel
RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)

Remark  All dimensions in this figure must be evaluated before use.
RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering
- Peak reflow temperature: 260°C or below (package surface temperature)
- Time of peak reflow temperature: 10 seconds or less
- Time of temperature higher than 220°C: 60 seconds or less
- Time to preheat temperature from 120 to 180°C: 120±30 s
- Number of reflows: Three
- Flux: Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow

(2) Wave soldering
- Temperature: 260°C or below (molten solder temperature)
- Time: 10 seconds or less
- Preheating conditions: 120°C or below (package surface temperature)
- Number of times: One
- Flux: Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron
- Peak temperature (lead part temperature): 350°C or below
- Time (each pins): 3 seconds or less
- Flux: Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions
- Fluxes
  Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.
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  2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.